

DECLARATION AND POWER OF ATTORNEY

We, the undersigned, verily believe we are the original, first, and joint inventors of the subject matter of the invention or discovery entitled "METHOD FOR MAINTAINING SOLDER THICKNESS IN FLIPCHIP ATTACH PACKAGING PROCESSES," U.S. Patent Application Serial No. 10/678,010, filed October 2, 2003, for which a patent is sought; that we have reviewed and understand the contents of the above-identified specification, including the claims referred to, and that we acknowledge the duty to disclose information which is material to the examination of this application in accordance with Section 1.56(a) of Title 37 of the Code of Federal Regulations.

We hereby claim the benefit under 35 U.S.C. Section 119(e) of United States Provisional Application No. 60/417,800, filed October 3, 2002,

We declare further that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful, false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful, false statements may jeopardize the validity of the application or any patent issuing thereon.

We hereby appoint as our attorneys and/or patent agents: Berne C. Broadbent, Reg. No. 30,550; Julie H. Gheem, Reg. No. 47,592; Kenneth E. Horton. Reg. No. 39,481; Dale E. Hulse, Reg. No. 29,654; Christopher L. Johnson, Reg. No. 46,809; Michael F. Krieger, Reg. No. 35,232; David B. Tingey, Reg. No. 52,289; Alexis V. Nelson, Reg. No. 52,321; and Todd E. Zenger, Reg. No. 33,610; with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. All correspondence and telephonic communications should be directed to:

Kenneth E. Horton KIRTON & McCONKIE 1800 Eagle Gate Tower 60 East South Temple Salt Lake City, Utah 84111 Wherefore, we pray that Letters Patent be granted to us for the invention or discovery described and claimed in the foregoing specification and claims, declaration and power of attorney, and this petition.

Signature Name (Print) Consuelo N. Tangpuz Date: Dec 8 '2013 Nationality Filipino Address 464 Maximo Patalinghug Jr. Ave. Pajo, Lapulapu City, Cebu Philippines 6015	Signature Associated Name (Print) Romel N. Manatad Date: Dec. & 1003 Nationality Filipino Address 1101 H. Cortes ST., Subangdaku Mandaue City, Cebu Philippines 6014
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